

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT7351580

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	TAKESHI YANAGITA	10/20/2017
	MASAAKI TAKIZAWA	10/20/2017
	YUUJI NISHIMURA	10/30/2017
	SHINICHI ARAKAWA	10/20/2017
	YUUGO NAKAMURA	10/26/2017
	YOHEI CHIBA	10/30/2017
RECEIVING PARTY DATA		
Name:	SONY SEMICONDUCTOR SOLUTIONS CORPORATION	
Street Address:	4-14-1 ASAHI-CHO	
Internal Address:	ATSUGI-SHI	
City:	KANAGAWA	
State/Country:	JAPAN	
Postal Code:	243-0014	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	17364227
CORRESPONDENCE DATA		
Fax Number:	(303)863-0223	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	303-863-9700	
Email:	sony@sheridanross.com	
Correspondent Name:	SHERIDAN ROSS P.C.	
Address Line 1:	1560 BROADWAY	
Address Line 2:	SUITE 1200	
Address Line 4:	DENVER, COLORADO 80202-5141	
ATTORNEY DOCKET NUMBER:	6810-998-CON-4	
NAME OF SUBMITTER:	JOANNA MONTGOMERY	
SIGNATURE:	/Joanna Montgomery/	
DATE SIGNED:	05/26/2022	

PATENT

Total Attachments: 6

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**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN
APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE**

Title of
Invention

IMAGING ELEMENT, DRIVING METHOD, AND ELECTRONIC DEVICE

As the below named inventor, I hereby declare that:

This declaration
is directed to:



The attached application, or



United States application or PCT international application number PCT/JP2016/065591

filed on 2016/05/26

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

WHEREAS, SONY SEMICONDUCTOR SOLUTIONS CORPORATION, with offices at
4-14-1 Asahi-cho, Atsugi-shi, Kanagawa, Japan (hereinafter referred to as ASSIGNEE), is desirous of
acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar
legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency
of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and
legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and
in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to
any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American
Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America
adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the
United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters
Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its
designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further
remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of
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And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said
application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will
testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with
this assignment and sale.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of
not more than five (5) years, or both.

LEGAL NAME OF INVENTOR

Inventor: TAKESHI YANAGITA

Date: October 20, 2017

Signature: Takeshi Yanagita

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LEGAL NAME OF INVENTOR

Inventor: MASAAKI TAKIZAWA

Date: October 20, 2017

Signature: Masaaki Takizawa

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LEGAL NAME OF INVENTOR

Inventor: yuuji nishimura

Date: October 30, 2017

Signature: Yuuji Nishimura

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LEGAL NAME OF INVENTOR

Inventor: SHINICHI ARAKAWA

Date: October 20, 2017

Signature: Shinichi Arakawa

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LEGAL NAME OF INVENTOR

Inventor: yuugo nakamura

Date: October 26, 2017

Signature: Yuugo Nakamura

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LEGAL NAME OF INVENTOR

Inventor: yohei chiba

Date: October, 30, 2017

Signature: yohei chiba